

v02.1101

HMC156C8

GaAs MMIC SMT PASSIVE FREQUENCY DOUBLER, 0.7 - 2.4 GHz INPUT

Typical Applications

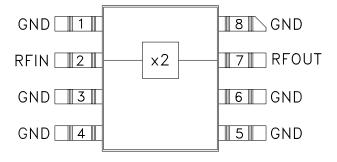
The HMC156C8 is suitable for:

- Wireless Local Loop
- LMDS, VSAT, and Pt to Pt Radios
- UNII & HiperLAN
- Test Equipment

11

FREQ. MULTIPLIERS - SM⁻

Functional Diagram



Features

Conversion Loss: 15 dB Fo, 3Fo, 4Fo Isolation: 38 dB Input Drive Level: 10 to 20 dBm

General Description

The HMC156C8 is a miniature frequency doubler in a non-hermetic ceramic surface mount package. Suppression of undesired fundamental and higher order harmonics is 38 dB typical with respect to input signal levels. The doubler uses the same diode/balun technology used in Hittite MMIC mixers, features small size and requires no DC bias.

Electrical Specifications, $T_A = +25^{\circ} C$, As a Function of Drive Level

	Input = +10 dBm			Input = +15 dBm			Input = +20 dBm			
Parameter	Min.	Тур.	Max.	Min.	Тур.	Max.	Min.	Тур.	Max.	Units
Frequency Range, Input	1.1 - 2.1			0.8 - 2.4			0.7 - 2.3			GHz
Frequency Range, Output	2.2 - 4.2			1.6 - 4.8			1.4 - 4.6			GHz
Conversion Loss		17	22		15	20		15	20	dB
FO Isolation (with respect to input level)	42	47		43	47		27	35		dB
3FO Isolation (with respect to input level)	45	55		44	55		29	40		dB
4FO Isolation (with respect to input level)	28	38		31	38		25	35		dB

11 - 2

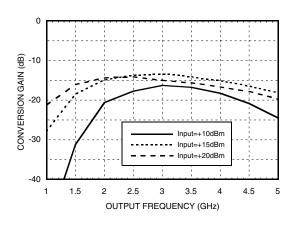


Conversion Gain vs. Drive Level

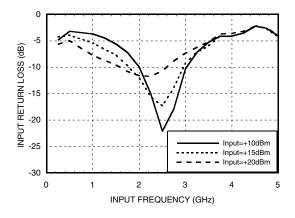
HMC156C8

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Isolation @ +15 dBm Drive Level*

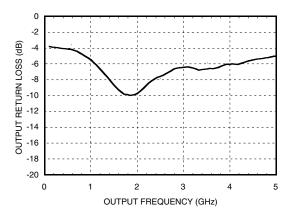


Input Return Loss vs. Drive Level



0 -10 -20 -30 -30 -40 -50 -50 -70 -70 Fo -80 3Fo 4Fc -90 -100 0 1 2 3 4 5 7 8 9 10 6 FREQUENCY (GHz)

Output Return Loss @ +15 Drive Level



11

For price, delivery, and to place orders, please contact Hittite Microwave Corporation: 12 Elizabeth Drive, Chelmsford, MA 01824 Phone: 978-250-3343 Fax: 978-250-3373 Order Online at www.hittite.com

^{*}With respect to input level



HMC156C8

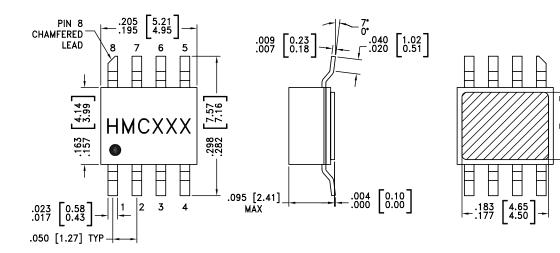
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Absolute Maximum Ratings

Input Drive	+27 dBm			
Storage Temperature	-65 to +150 °C			
Operating Temperature	-40 to +85 °C			

11

Outline Drawing



NOTES:

- 1. PACKAGE BODY MATERIAL: WHITE ALUMINA 92%
- 2. LEAD, PACKAGE BOTTOM MATERIAL: COPPER
- 3. PLATING: ELECTROLYTIC GOLD 100 200 MICROINCHES OVER ELECTROLYTIC NICKEL 100 TO 200 MICROINCHES.
- 4. DIMENSIONS ARE IN INCHES [MILLIMETERS].
- 5. PACKAGE LENGTH AND WIDTH DIMENSIONS DO NOT INCLUDE LID SEAL PROTRUSION .005 PER SIDE.
- 6. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB PF GROUND.

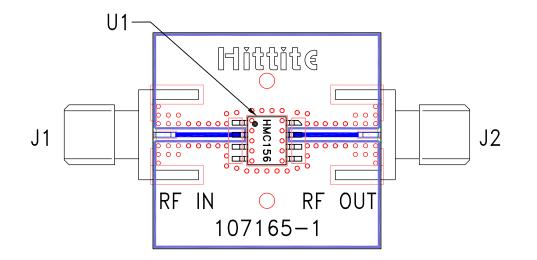


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Evaluation PCB



List of Materials

Item	Description	
J1, J2	PC Mount SMA Connector	
U1	HMC156C8, Doubler	
PCB*	107165 Eval Board	
* Circuit Board Material: Rogers 4350		

The circuit board used in the final application should be generated with proper RF circuit design techniques. Signal lines should have 50 ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. The evaluation circuit board shown is available from Hittite upon request. 11

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